MOSFETs Silicon N-channel MOS (U-MOSIX-H)

# TPN4R806PL

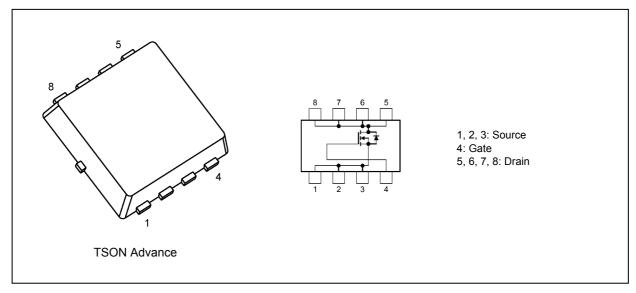
### 1. Applications

- DC-DC Converters
- Switching Voltage Regulators
- Motor Drivers

### 2. Features

- (1) High-speed switching
- (2) Small gate charge:  $Q_{SW} = 9.5 \text{ nC}$  (typ.)
- (3) Small output charge:  $Q_{oss} = 24 \text{ nC}$  (typ.)
- (4) Low drain-source on-resistance:  $R_{DS(ON)} = 3.5 \text{ m}\Omega \text{ (typ.)} (V_{GS} = 10 \text{ V})$
- (5) Low leakage current:  $I_{DSS} = 10 \ \mu A \ (max) \ (V_{DS} = 60 \ V)$
- (6) Enhancement mode:  $V_{th}$  = 1.5 to 2.5 V ( $V_{DS}$  = 10 V,  $I_D$  = 0.3 mA)

### 3. Packaging and Internal Circuit



### 4. Absolute Maximum Ratings (Note) (T<sub>a</sub> = 25 °C unless otherwise specified)

Characterist	tics		Symbol	Rating	Unit
Drain-source voltage			V <sub>DSS</sub>	60	V
Gate-source voltage			V <sub>GSS</sub>	±20	]
Drain current (DC)	(T <sub>c</sub> = 25 °C)	(Note 1)	Ι <sub>D</sub>	72	A
Drain current (DC)	(Silicon limit)	(Note 1), (Note 2)		105	]
Drain current (pulsed)	(t = 100 μs)	(Note 1)	I <sub>DP</sub>	200	
Power dissipation	(T <sub>c</sub> = 25 °C)		PD	104	W
Power dissipation		(Note 3)		2.67	]
Power dissipation		(Note 4)		0.63	
Single-pulse avalanche energy		(Note 5)	E <sub>AS</sub>	28	mJ
Single-pulse avalanche current		(Note 5)	I <sub>AS</sub>	72	A
Channel temperature			T <sub>ch</sub>	175	°C
Storage temperature			T <sub>stg</sub>	-55 to 175	

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

#### 5. Thermal Characteristics

Characteristics			Symbol	Max	Unit
Channel-to-case thermal resistance	(T <sub>c</sub> = 25 °C)		R <sub>th(ch-c)</sub>	1.43	°C/W
Channel-to-ambient thermal resistance	(T <sub>a</sub> = 25 °C)	(Note 3)	R <sub>th(ch-a)</sub>	56	
Channel-to-ambient thermal resistance	(T <sub>a</sub> = 25 °C)	(Note 4)	R <sub>th(ch-a)</sub>	235	

Note 1: Ensure that the channel temperature does not exceed 175 °C.

Note 2: Limited by silicon chip capability.

Note 3: Device mounted on a glass-epoxy board (a), Figure 5.1

Note 4: Device mounted on a glass-epoxy board (b), Figure 5.2

Note 5: V\_DD = 48 V, T\_ch = 25 °C (initial), L = 4.3  $\mu H, \, I_{AS}$  = 72 A

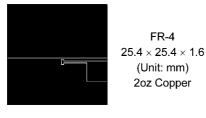
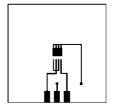


Fig. 5.1 Device Mounted on a Glass-Epoxy Board (a)



FR-4 25.4 × 25.4 × 1.6 (Unit: mm) 2oz Copper

Fig. 5.2 Device Mounted on a Glass-Epoxy Board (b)

Note: This transistor is sensitive to electrostatic discharge and should be handled with care.

#### 6. Electrical Characteristics

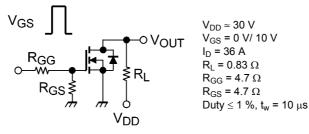
### 6.1. Static Characteristics (T<sub>a</sub> = 25 °C unless otherwise specified)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage current	I <sub>GSS</sub>	$V_{GS}$ = ±20 V, $V_{DS}$ = 0 V	_	_	±0.1	μA
Drain cut-off current	I <sub>DSS</sub>	V <sub>DS</sub> = 60 V, V <sub>GS</sub> = 0 V			10	
Drain-source breakdown voltage	V <sub>(BR)DSS</sub>	I <sub>D</sub> = 10 mA, V <sub>GS</sub> = 0 V	60	—	—	V
Drain-source breakdown voltage (Note 6)	V <sub>(BR)DSX</sub>	I <sub>D</sub> = 10 mA, V <sub>GS</sub> = -20 V	45	_	_	
Gate threshold voltage	V <sub>th</sub>	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 0.3 mA	1.5		2.5	
Drain-source on-resistance	R <sub>DS(ON)</sub>	V <sub>GS</sub> = 4.5 V, I <sub>D</sub> = 12 A		6.2	9.1	mΩ
		V <sub>GS</sub> = 10 V, I <sub>D</sub> = 36 A	_	3.5	4.8	

Note 6: If a reverse bias is applied between gate and source, this device enters V<sub>(BR)DSX</sub> mode. Note that the drainsource breakdown voltage is lowered in this mode.

### 6.2. Dynamic Characteristics ( $T_a = 25$ °C unless otherwise specified)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Input capacitance	C <sub>iss</sub>	V <sub>DS</sub> = 30 V, V <sub>GS</sub> = 0 V, f = 1 MHz	_	2130	2770	pF
Reverse transfer capacitance	C <sub>rss</sub>		—	45	90	
Output capacitance	C <sub>oss</sub>		_	360	—	
Gate resistance	r <sub>g</sub>	—	_	0.8	1.3	Ω
Switching time (rise time)	tr	See Fig. 6.2.1	_	4.0	—	ns
Switching time (turn-on time)	t <sub>on</sub>		_	15	_	
Switching time (fall time)	t <sub>f</sub>		_	5.1	_	
Switching time (turn-off time)	t <sub>off</sub>		_	27	_	



#### Fig. 6.2.1 Switching Time Test Circuit

#### 6.3. Gate Charge Characteristics ( $T_a = 25$ °C unless otherwise specified)

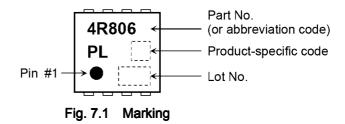
Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Total gate charge (gate-source plus	Qg	$V_{DD} \approx 30$ V, $V_{GS}$ = 10 V, $I_D$ = 36 A	_	29	_	nC
gate-drain)		$V_{DD} \approx 30$ V, $V_{GS}$ = 4.5 V, $I_D$ = 36 A	_	14	_	
Gate-source charge 1	Q <sub>gs1</sub>	$V_{DD} \approx 30$ V, $V_{GS}$ = 10 V, $I_D$ = 36 A	_	8.0	_	
Gate-drain charge	Q <sub>gd</sub>		_	5.5	_	
Gate switch charge	Q <sub>SW</sub>		_	9.5	—	
Output charge	Q <sub>oss</sub>	V <sub>DS</sub> = 30 V, V <sub>GS</sub> = 0 V, f = 1 MHz	_	24	_	

### 6.4. Source-Drain Characteristics ( $T_a = 25$ °C unless otherwise specified)

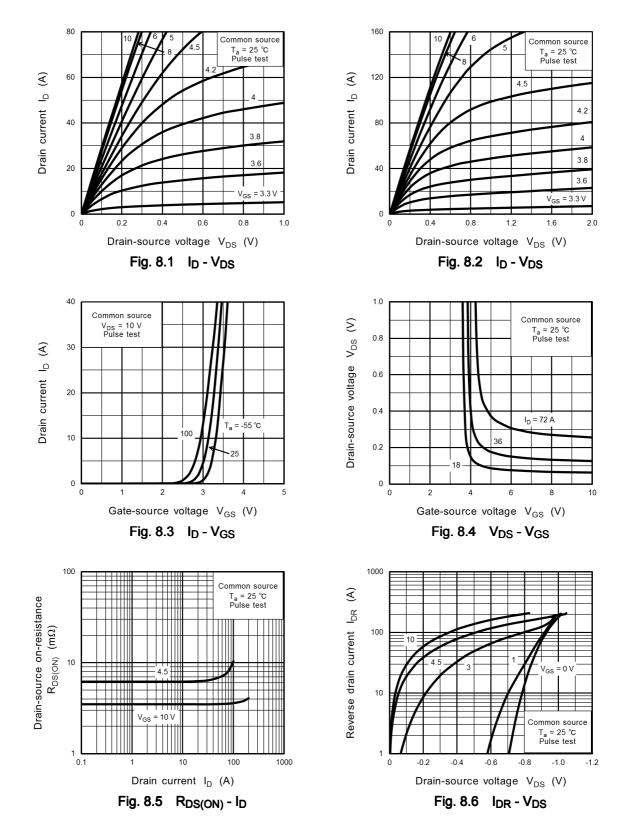
Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Reverse drain current (pulsed) (Note 7	I <sub>DRP</sub> (t = 100 μs)	—	—	—	200	A
Diode forward voltage	V <sub>DSF</sub>	I <sub>DR</sub> = 72 A, V <sub>GS</sub> = 0 V	_	_	-1.2	V
Reverse recovery time	t <sub>rr</sub>	I <sub>DR</sub> = 18 A, V <sub>GS</sub> = 0 V,	_	31	_	ns
Reverse recovery charge	Q <sub>rr</sub>	-dI <sub>DR</sub> /dt = 100 A/μs		26	_	nC

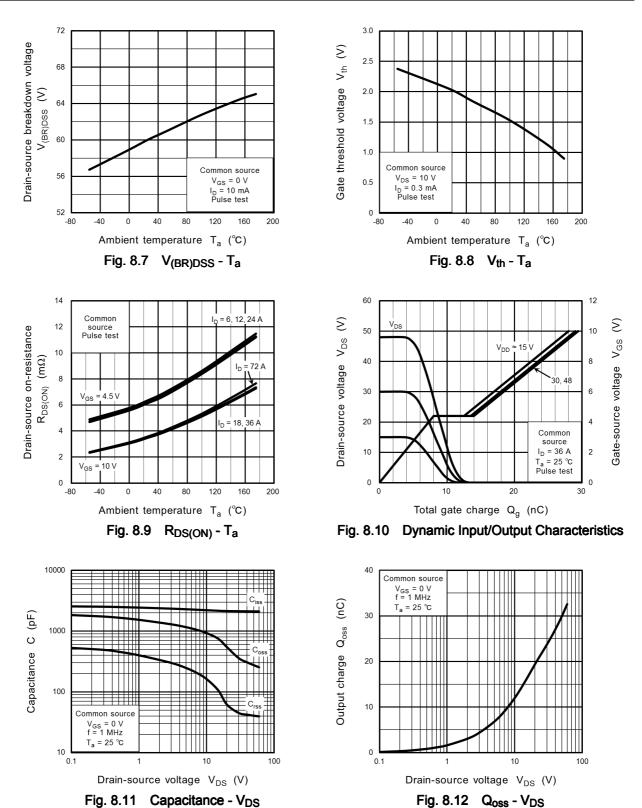
Note 7: Ensure that the channel temperature does not exceed 175  $^\circ \! \text{C}.$ 

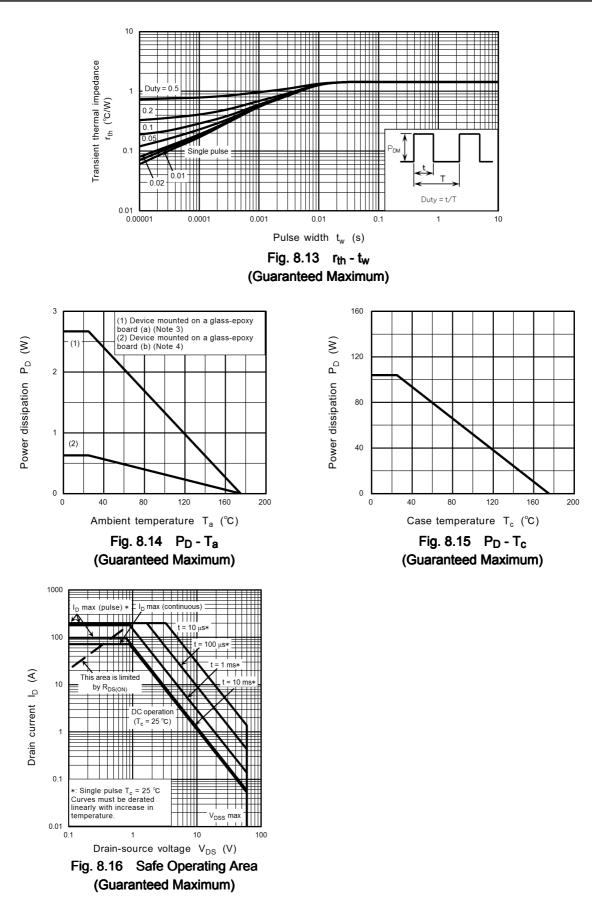
### 7. Marking



### 8. Characteristics Curves (Note)







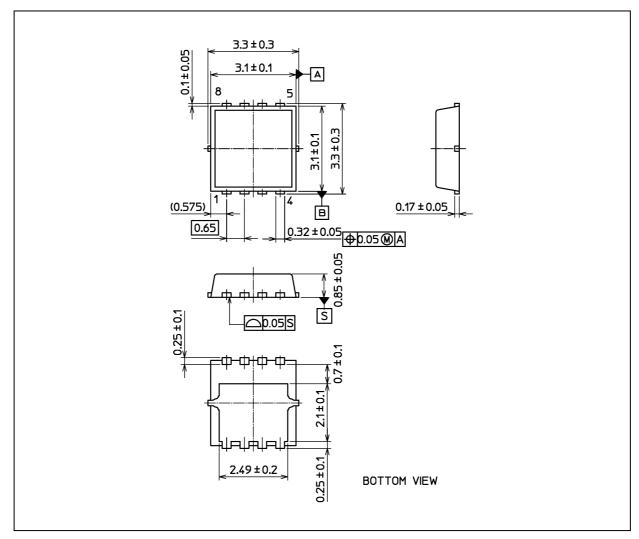
Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.



### TPN4R806PL

### **Package Dimensions**

Unit: mm



Weight: 0.02 g (typ.)

Package Name(s)
TOSHIBA: 2-3X1S
Nickname: TSON Advance

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